

Overview

Icon Descriptions

The icons are used in the manual to serve as an indication of interest topics or important messages. Below is a description of these icons:



NOTE: This mark indicates that there is a note of interest and is something that you should pay special attention on while using the product



WARNING: This mark indicates that there is a caution or warning and it is something that could damage your property or product

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Compliances and Certification

CE Certification

This product has passed the CE test for environmental specifications. Test conditions for passing included the equipment being operated within an industrial enclosure. In order to protect the product from being damaged by ESD (Electrostatic Discharge) and EMI leakage, we strongly recommend the use of CE-compliant industrial enclosure products.

FCC Class A Certification

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

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Chapter 1.

Chapter 1: Introduction

Thank you for choosing the AOPS-7080. The AOPS-7080 is an Open Pluggable Specification (OPS) for IWB and digital signage application. The AOPS-7080 addresses IWB and digital signage market fragmentation and simplify device installation, usage, maintenance, and upgrades.

This OPS provides a rich I/O capabilities via highbandwidth interfaces such as PCI Express 2.0, Serial ATA 3.0, and Hi- Speed USB 3.0 connectivity.

Other I/O capabilities include an HDMI port, a MIC-In and Line Out as well as an Intel® i210 Gigabit Ethernet.



Warning:

While using the OPS, do not disconnect the power source. It will be Cause fatal failure

System Specification

System			
CPU	Intel® Core TM i5-4400E Processor (3M Cache, up to 3.30 GHz)		
BIOS	AMI SPI BIOS		
System chipset	Intel® QM87 Express Chipset		
System Memory	DDR3L-1333, 4GB (2GB x 2)		
	Ι / Ο		
Storage	2.5" SDD 128GB		
USB	2x USB 3.0 Type A in front panel3x USB 2.0 and 1x USB 3.0 through JAE TX2580- pin connector		
Mini- PCIe	1x mini-PCIexpress socket for mini-card module		
	Display		
Chipset	Intel® integrated HD 4600		
Display Supported	HDMI: Display port and TMDS through JAE TX25 80-pin connector		
	Audio Interface		
Chipset	Realtek ALC886		
Interface	Mic-in, Line-out : Audio L/R through JAE TX25 80-pin connector		
	Ethernet		
LAN Chip	Intel® i210 Gigabit Ethernet		
Ethernet	1x10/ 100/ 1000 Base-Tx Gigabit Ethernet		
Mechanical & Environmental			
Power Requirement	DC 12V, 5A		
Operating Temperature	-5°C to +45°C (32 ~ 140°F)		
Storage Temperature	-20°C to +75°C (-4 ~ 158°F)		
Size (L x W x H)	119mm(D) x 200mm(W) x 30mm(H) (4.69" x 7.87" x 1.18")		
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Chapter 1.

Package Contents

 \cdot If any items are missing, contact your dealer.

Your package contains the following items:

- AOPS-7080 OPS System (installed Set)
- Drivers and User's Manual CD
- Adaptor DC12V, 5A

Chapter 2.

Chapter 2: System Components

System Drawing

Mechanical dimensions of the AOPS-7080. Unit: mm



Chapter 2.



Component	Description	Pin Definition Reference
F1 Hard Disk Slot	External 2.5" hard drive bay for easy access	
	and replacement of the data storage. It sup-	
	ports SATA 3.0 specification	
F2 Antenna Hole	Reserved hole for 3G/Wi-Fi module antenna	
F3 Gigabit Ethernet LAN port controller which supports10/100/1000Mbps connection speeds and PXE (Preboot eXecution Environment). The LAN port LED indicator is described below:		
	LINK/ACT (Amber)	
	 On/Flashing: The port is linking and active in data transmission. 	
	Off: The port is not linking.	
	SPEED (Green/Yellow)	
	 Yellow: The connection speed is 1000Mbps. 	
	Green: The connection speed is 100Mbps	
	Off: The connection speed is 10Mbps.	
F4 USB 3.0 type A ports	Two USB 3.0 type A ports	USB1 on page 11
R5 HDMI Port (*)	An HDMI port (single link) which is provided by Intel integrated HD 4600	HDMI1 on page 10
F6 Power-on Button with Dual LED	ATX power-on button with LEDs: stand-by mode in red; power-on mode in green.	
F7 Reset Button	A hardware reset button	
F8 Mic-in Port/Line-out	Connect audio devices to these port.	MIC1/LINE1 on page 10
F9 HDD (Green) and	HDD	
Power LED (Green)	Blinking: data access activities	
one LED (Oreen)	Off: no data access activities	
	Power	
	On: The computer is on.	
	Off: The computer is off .	

Chapter 2.

Rear Connectors



Component	Description	Pin Definition Reference
R1 TX-25 80-pin connector	This connects to the docking board-LEK-IOB2	OPS1 on page 10

Connectors and Jumpers List

Chapter 3.

Chapter 3: Board connector

Connectors and Jumpers List

The tables below list the function of each of the board connectors by labels shown in the above section. The next section in this chapter gives pin definitions.

Label	Function	Pin Definition Ref. Page
OPS Connector	JAE TX-25 80-pin Connectors	Page 10
Line 1	Line-out Phone Jack	Page 10
MIC 1	MIC-in Phone Jack	Page 10
HDMI 1	HDMI Connector	Page 10
LAN 1	LAN Port	Page 11
USB 1	Dual Stack USB type A Connector	Page 11
MPCIE 1	Mini-PCIe Connector	Page 11
CMOS 1	Clear CMOS Jumper (Inside of set)	Page 11

Chapter 3.

OPS Connector (OPS1)

PIN	Signal	PIN	Signal
1	DDP_3N	41	RSVD
2	DDP 3P	42	RSVD
3	GND	43	RSVD
4	DDP_2N	44	RSVD
5	DDP_2P	45	RSVD
6	GND	46	RSVD
7	DDP 1N	47	RSVD
8	DDP 1P	48	RSVD
9	GND	49	RSVD(DDP
			AUX EN)
10	DDP ON	50	SYS_FAN_EN
11	DDP OP	51	UART RX
12	GND	52	UART TX
13	DDP_AUXN	53	GND
14	DDP_AUXP	54	Stda_SSRX-
15	DDP HPLUG	55	Stda SSRX+
16	GND	56	GND
17	TMDS_CLKN	57	Stda_SSTX-
18	TMDS_CLKP	58	Stda_SSTX+
19	GND	59	GND
20	TMDSON	60	USB PN2
21	TMDSOP	61	USB PP2
22	GND	62	GND
23	TMDS1N	63	USB PN1
24	TMDS1P	64	USB PP1
25	GND	65	GND
26	TMDS2N	66	USB PNO
27	TMDS2P	67	USB PP0
28	GND	68	GND
29	TMDS_DDC_	69	AZ_LINEOUT_L
	DATA		855 855
30	TMDS_DDC_	70	AZ_LINEOUT_R
	CLK	550 TO	
31	TMDS HPLUG	71	CEC
32	GND	72	PB DET
33	DC_IN	73	PS ON#
34	DC_IN	74	PWR STATUS
35	DC_IN	75	GND
36	DC_IN	76	GND
37	DC_IN	77	GND
38	DC IN	78	GND
39	DC_IN	79	GND
40	DC IN	80	GND

Line-out Jack (Line 1)

PIN	Signal	
1	LINE_OUT_R	
2	N.C	
3	LINE_OUT_L	
4	EARPHONE DET	
5	GND	
6	GND	

Microphone Jack (MIC1)

PIN	Signal	
1	MIC_R	
2	N.C	
3	MIC_L	
4	MIC DET	
5	GND	
6	GND	

High-Definition Multimedia Interface (HDMI1)



PIN NO.	Signal	PIN NO.	Signal
1	DATA2+	2	GND
3	DATA2-	4	DATA1+
5	GND	6	DATA1-
7	DATA0+	8	GND
9	DATA0-	10	CLK+
11	GND	12	CLK-
13	N.C	14	N.C
15	DDC CLK	16	DDC DAT
17	GND	18	HDMI_VCC
19	HPD		

Chapter 3.

Gigabit Ethernet (LAN1)

Pin No.	Signal		
	Fast Ethernet	Gigabit Ethernet	
1	TX+	MD0+	
2	TX-	MD0	
3	RX+	MD1+	
4	T45	MD2+	
5	T45	MD2-	
6	RX-	MD1-	
7	T78	MD3+	
8	T78	MD3-	
9	10-/100-/1000+		
10	10+/100+/1000-		
11	Link+/ACT-		
12	Link-/ACT+		

Dual Stack USB 3.0 Type A Connector (USB1)



PIN NO.	Signal	PIN NO.	Signal
1	USB_VCC1	10	USB_VCC2
2	USB1_D-	11	USB2 D-
3	USB1_D+	12	USB2_D+
4	GND	13	GND
5	USB1_RX-	14	USB2_RX-
6	USB1_RX+	15	USB2_RX+
7	GND	16	GND
8 9	USB1 TX-	17	USB2 TX-
9	USB1_TX+	18	USB2_TX+

Mini PCI-Express with SIM Card Reader(MPCIE1)

PIN NO.	Signal	PIN NO.	Signal	
1	WAKE#	2	+3.3V	
3	RSVD	4	GND	
3 5	RSVD	6	+1.5V	
	GND	13	GND	
7	CLKREQ#	8	UIM_PWR	
9	GND	10	UIM DATA	
11	REFCLK-	12	UIM CLK	
13	REFCLK+	14	UIM_RESET	
15	GND	16	UIM VPP	
		Key		
17	RSVD	18	GND	
19	RSVD	20	W DISABLE#	
21	GND	22	PERST#	
23	PERn0	24	+3.3V	
25	PERp0	26	GND	
27	GND	28	+1.5V	
29	GND	30	SMB_CLK	
31	PETn0	32	SMB DATA	
33	PETp0	34	GND	
35	GND	36	USB D+	
37	GND	38	USB D-	
39	+3.3V	40	GND	
41	+3.3V	42	LED WWAN#	
43	GND	44	LED_WLAN#	
45	RSVD	46	LED WPAN#	
47	RSVD	48	+1.5V	
49	RSVD	50	GND	
51	RSVD	52	+3.3V	

Clear CMOS Jumper (CMOS1)

	PIN No.	Signal
	1-2	Normal (Default)
3 2 1	2-3	Clear CMOS

Chapter 4.

Chapter 4: Hardware Setup

Preparing the Hardware Installation

To access some components and perform certain service procedures, you must perform the following procedures first.



WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. Portions of the power supply and some internal circuitry remain active until power is removed.

- 1. Unpowered the AOPS-7080 and make sure that the power source is removed.
- 2. It is not required to remove the system's top cover for installing most parts of the system such as the memory, 3G wireless module, SIM card, and the hard disk.

Installing the System Memory

The motherboard supports DDR3L memory that features data transfer rates of 1333 MHz to meet the higher bandwidth requirements of the latest operating system and Internet applications. It comes with one Double Data Rate 3 Low Voltage (DDR3L) Small Outline Dual Inline Memory Module (SO-DIMM) socket.

- 1. Put the device upside down.
- 2. Take off the cover of the memory compartment by unscrewing two screws from its cover.
- 3. Align the memory module's key with the SO-DIMM socket's key.
- 4. Install the SO-DIMM.
- 5. Install the cover back to the system.





Note:



 SO-DIMMs installed should meet the required speed which is DDR3L 1333 MHz. Do not install SO-DIMM supporting different speeds.
 The motherboards can support up to 16 GB memory capacity in maximum.

Chapter 4.

3G and Wireless Module Installation(Optional)

- 1. Take out the Mini-PCIe and SIM card compartment's cover by unscrewing the screws on the cover.
- 2. Align the wireless module's cutout with the Mini-PCIe slot notch.
- 3. Insert the wireless module into the connector diagonally.
- 4. Push the other end of the wireless module and secure it in place with the screws.
- 5. Install the Antenna to the module.

3G SIM Card Installation(Optional)

- 1. Take out the Mini-PCIe and SIM compartment's cover by unscrewing the screws on the cover.
- 2. Unlock the SIM card tray by sliding it outward and open it.
- 3. Place the SIM card in the tray. Make sure the ICs is in contact with the socket. The angled corner of the SIM ensures that the card fits only the correct way in the tray.
- 4. Close and lock the tray. You should feel a click when the SIM card is locked securely in the socket.



Installing the Hard Disk

The system can accommodate one Serial-ATA 2.5" disk. Follow these steps to install a hard disk into the AOPS-7080):

- 1. Take out the hard disk tray from the system.
- 2. Place hard disk on the hard disk tray and align the holes of the hard disk with the mounting holes on the tray.
- 3. Fix the hard disk on the hard disk tray by using 2 mounting screws
- 4. Push the hard disk into the hard disk slot and secure it with a screw.







Note:

The system only accommodates 2.5" SSD. It supports SATA 3.0 specification.

Appendix A: Terms and Conditions

Warranty Policy

- 1. All products are under warranty against defects in materials and workmanship for a period of one year from the date of purchase.
- 1. Compensation standard of our products in accordance with the Ministry of Finance Notice legitimate consumer damage will be compensated.

Product Warranty

Product :	Model :	Purchase a day :	year	month	day
Customer Name :	Phone :	Address :			
Mutual agency :	Phone :	Address :			

• When requesting repairs and the year of purchase date must be presented above Enough to receive service so please keep it.

- Major parts of the retention period is 2 years.
- 1. Warranty for this product to ensure the information contained in the warranty benefits.
- 2. The warranty period calculated from the date of purchase dated, so please come (Date of purchase. If this should not check 6 months from date of manufacture from the date of the warranty period shall be added to.)
- 3. Not household products also(operating activities, unusual environments, etc.), or industrial products. If the warranty period of 6 months will apply. (Key parts)
- 4. This warranty will not be reissued.

Compensation for consumers guide

				Details of compensation		
Type of consumer harm			Warranty information	After the warranty period		
(Components within	when within 10 days o	f purchase repair important requiring	Product exchange or The purchase price Refunds			
	when within 1 month	of purchase repair important requiring	Product exchange			
	When exchange goods within 1 month of purchase repair important requiring		The purchase price			
	When the exchange is	not possible	Refunds			
	When the re fair is	When Defective goods occurrence	Free fix	Charged repair		
	possible	Repair for the same Defective, but when recurrence of failures (4 time)	Product exchange			
	When the repair is not possible		or The purchase price Refunds	Duration of use based on the Depreciation		
	Do not have the repair parts and repair is not possible			Depreciation		
	if consumer requesting	repairs products, business lost it				
	At the time of purchase, transport process and product damage incurred during installation		Product exchange			
Due to negligence on the part of consumers performance, failure of functional	When the refair is	Failure due to use of power over				
	possible	Connection failures due to equipment failure	Charged repair	Charged repair		
	possible	Failure or defect caused by natural disasters				
	When the refair is not possible	Performance, functional failure or damage is not a defect in	After collecting the amount paid to repair the exchange of goods	Our standard Subject to determined a separate		
Consumer spontaneous decomposition	When the refair is not possible	Trail the decomposition of the consumer if the product	Can not be repaired	Can not be repaired		

• With regard to the product of the three defects in the compensation is not subject.



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